

# INTERNATIONAL STANDARD

## NORME INTERNATIONALE



**EMC IC modelling –**

**Part 6: Models of integrated circuits for pulse immunity behavioural simulation –  
Conducted pulse immunity modelling (ICIM-CPI)**

**Modèles de circuits intégrés pour la CEM –**

**Partie 6: Modèles de circuits intégrés pour la simulation du comportement  
d'immunité aux impulsions – Modélisation de l'immunité aux impulsions  
conduites (ICIM-CPI)**



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## INTERNATIONAL ELECTROTECHNICAL COMMISSION

## EMC IC MODELLING –

**Part 6: Models of integrated circuits for pulse immunity behavioural simulation – Conducted pulse immunity modelling (ICIM-CPI)**

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International Standard IEC 62433-6 has been prepared by subcommittee 47A: Integrated circuits, of IEC technical committee 47: Semiconductor devices.

The text of this International Standard is based on the following documents:

CDV	Report on voting
47A/1090/CDV	47A/1098/RVC

Full information on the voting for the approval of this International Standard can be found in the report on voting indicated in the above table.

This document has been drafted in accordance with the ISO/IEC Directives, Part 2.

A list of all parts in the IEC 62433 series, published under the general title *EMC IC modelling*, can be found on the IEC website.

The committee has decided that the contents of this document will remain unchanged until the stability date indicated on the IEC website under "<http://webstore.iec.ch>" in the data related to the specific document. At this date, the document will be

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## EMC IC MODELLING –

### Part 6: Models of integrated circuits for pulse immunity behavioural simulation – Conducted pulse immunity modelling (ICIM-CPI)

#### 1 Scope

The objective of this part of IEC 62433 is to describe the extraction flow for deriving an immunity macro-model of an Integrated Circuit (IC) against conducted Electrostatic Discharge (ESD) according to IEC 61000-4-2 and Electrical Fast Transients (EFT) according to IEC 61000-4-4.

The model addresses physical damages due to overvoltage, thermal damage and other failure modes. Functional failures can also be addressed.

This model allows the immunity simulation of the IC in an application. This model is commonly called "Integrated Circuit Immunity Model Conducted Pulse Immunity", ICIM-CPI.

The described approach is suitable for modelling analogue, digital and mixed-signal ICs. Several terminals of an IC can be part of a single model (e.g. input, output and supply pins). The implementation of the model is capable of representing the non-linear behaviour of overvoltage protection circuits.

The model can be implemented for the use in different software tools for circuit simulation in time-domain. The described modelling approach allows simulating device failure due to ESD or EFT at component and system level considering all components necessary for the immunity simulation of an IC, such as a PCB or external protection elements.

This document demonstrates, in detail, the construction of models in a defined XML-based format which is suitable for the exchange of models without any deeper knowledge of the semiconductor circuit. However, the model functionality can be implemented in different formats including, but not limited to, tables, SPICE[1] <sup>1</sup> netlists, hardware description languages such as VHDL-AMS [2] and Verilog-AMS [3].

This document provides:

- the description of ICIM-CPI macro-model elements representing electrical, thermal or logical behaviour of the IC.
- a universal data exchange format based on XML.

#### 2 Normative references

The following documents are referred to in the text in such a way that some or all of their content constitutes requirements of this document. For dated references, only the edition cited applies. For undated references, the latest edition of the referenced document (including any amendments) applies.

IEC 61000-4-2, *Electromagnetic compatibility (EMC) – Part 4-2: Testing and measurement techniques – Electrostatic discharge immunity test*

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<sup>1</sup> Numbers in square brackets refer to the bibliography.